

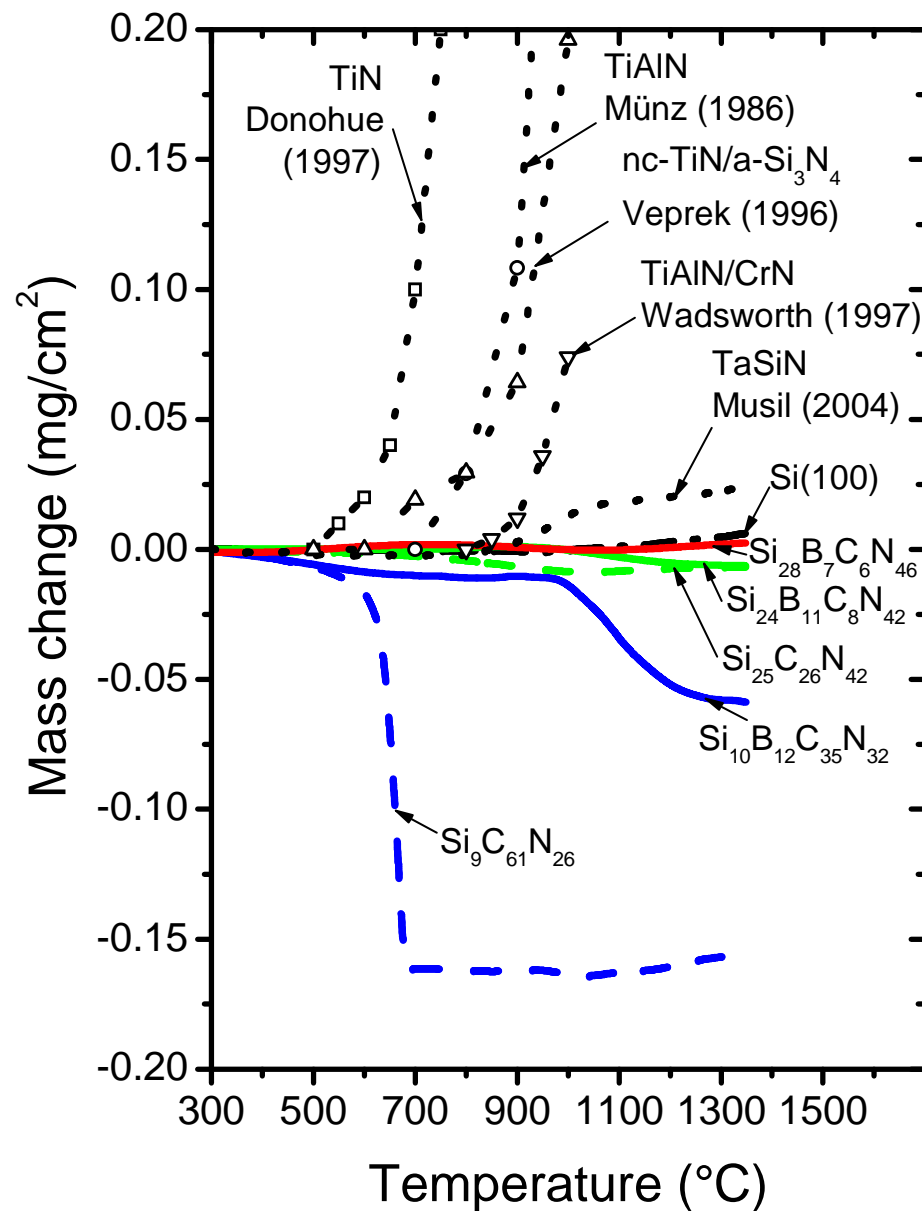
NEW Si-B-C-N COATINGS: AB-INITIO CALCULATIONS AND EXPERIMENTAL VERIFICATION

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Motivation for new quaternary Si-B-C-N materials: exceptional oxidation resistance

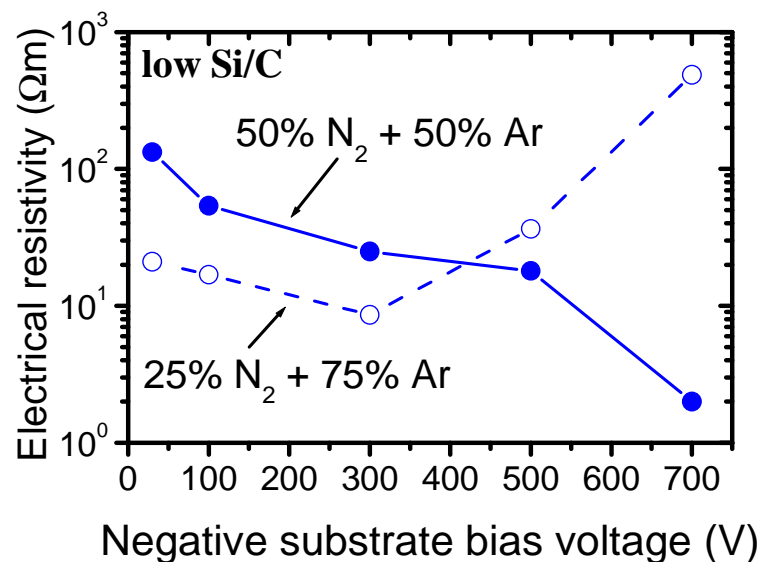
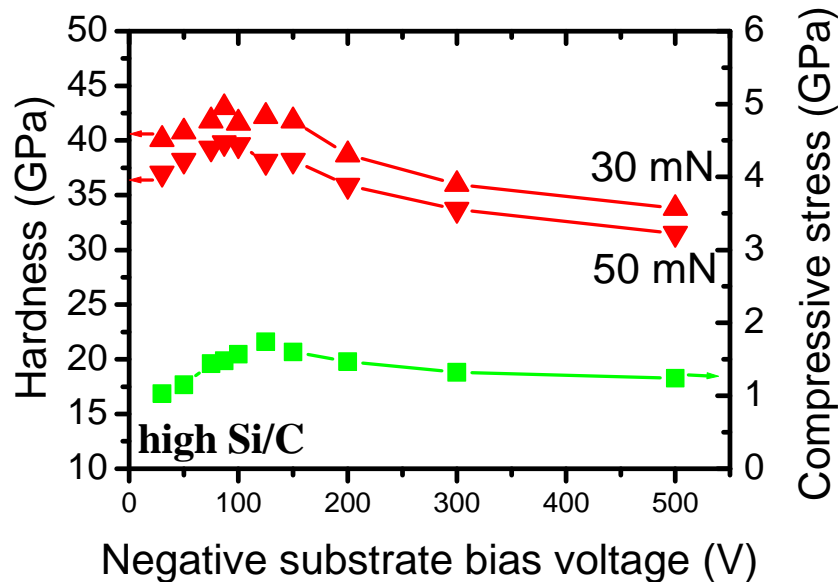
Solid: Si-B-C-N — — —

Dashed: Si-C-N - - - - - -

Dotted: other coatings

- Very high oxidation resistance (up to a 1350 °C substrate limit): important role of the Si/C ratio and the B content

[J. Vlcek et al., J. Vac. Sci. Technol. A 23, 1513 (2005)]



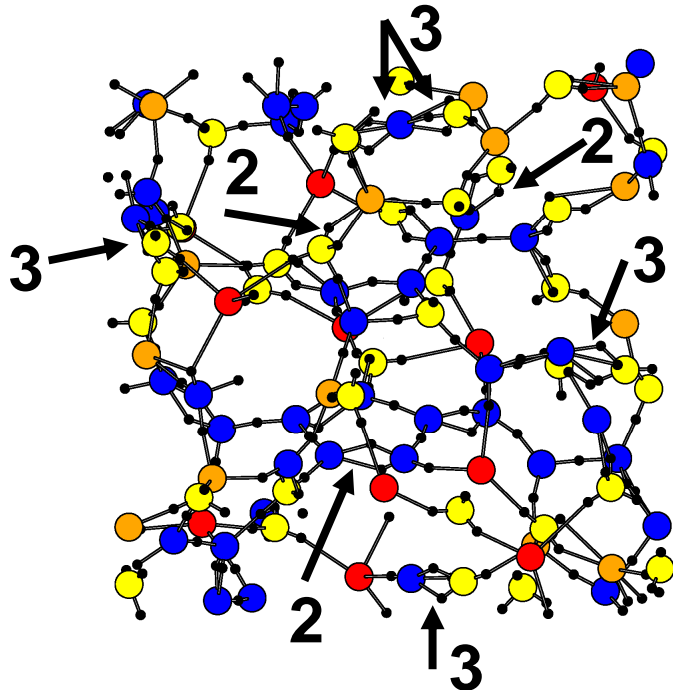
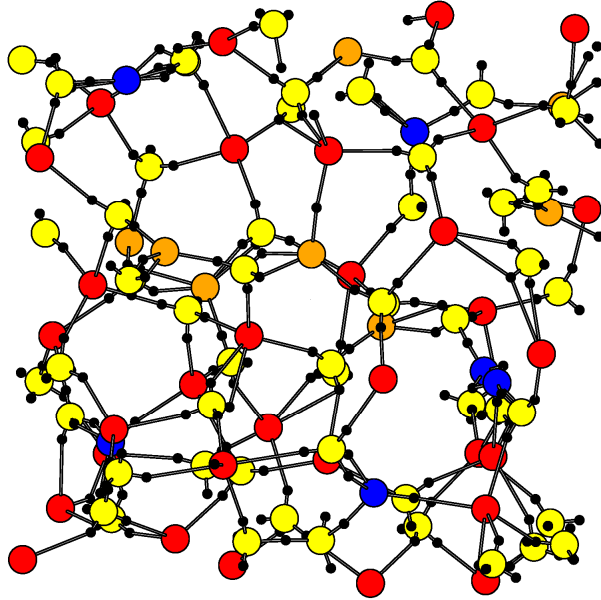
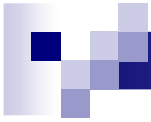
Controllable properties of sputtered Si-B-C-N materials - hardness, compressive stress, electrical conductivity

- Properties controlled by C-Si-B/ B_4C -Si composed target composition, N_2 -Ar gas mixture composition, negative rf substrate bias
- High hardness, very low stress, promising optical and electrical properties



SUPPORT OF AN EXPERIMENT BY AB-INITIO SIMULATIONS

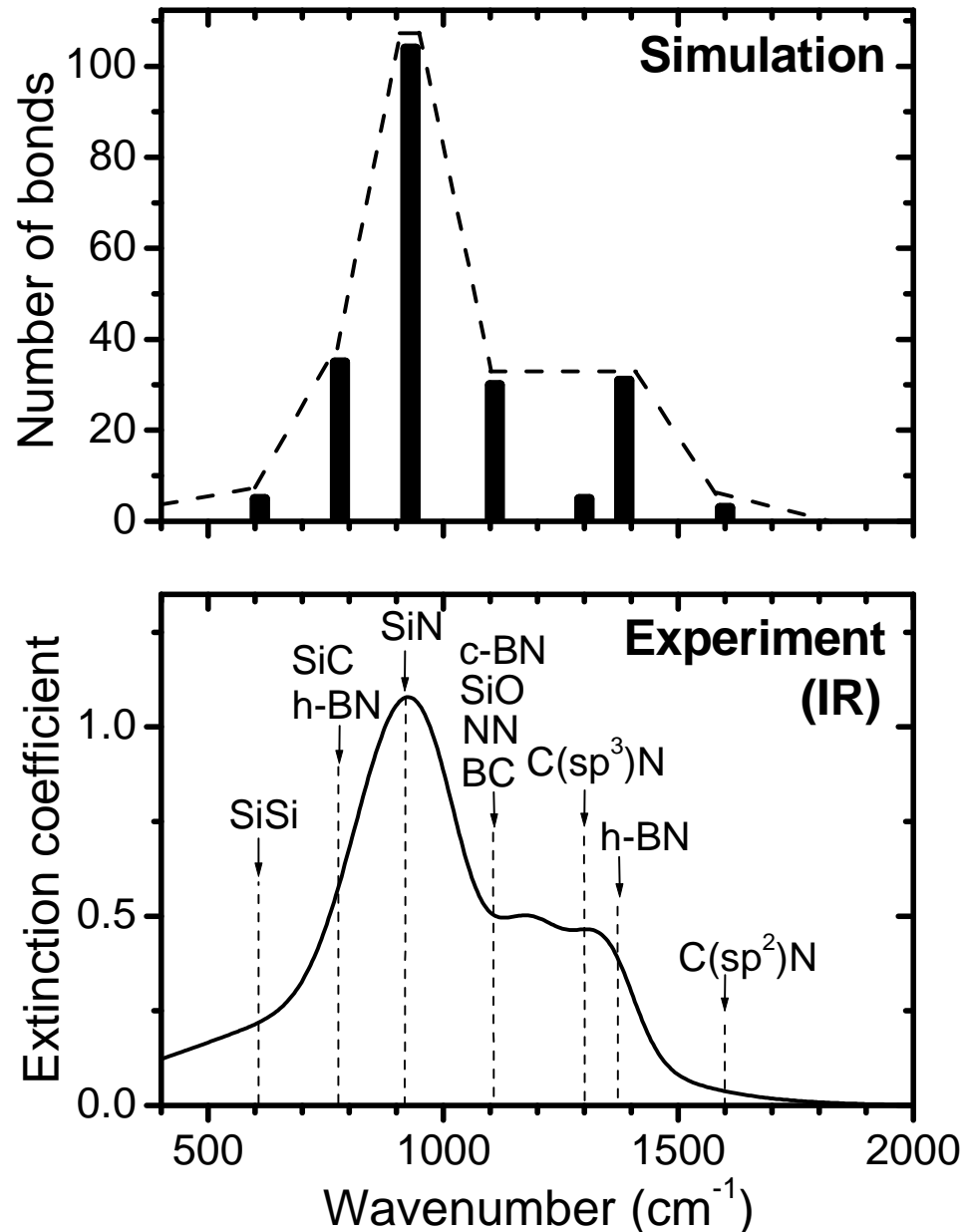
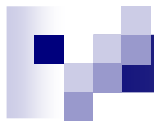
- **Density functional theory** (DFT) as implemented in the Car-Parrinello molecular dynamics (CPMD code)
- **Atom cores and inner electron shells** described by pseudopotentials (Goedecker type)
- **Valence electrons** described by Kohn-Sham (Schrödinger-like) equations expanded in a basis of plane-wave functions using BLYP functional
- **Liquid-quench algorithm** captures material formation conditions arising from rapid cooling of the localized melt around sites of energetic ion impact
- **3-dimensional periodical cubic cell** with ~100 atoms



Molecular-dynamics simulations of Si-B-C-N materials

Si: ●, B: ●, C: ●, N: ●,
2 valence electrons: —●—

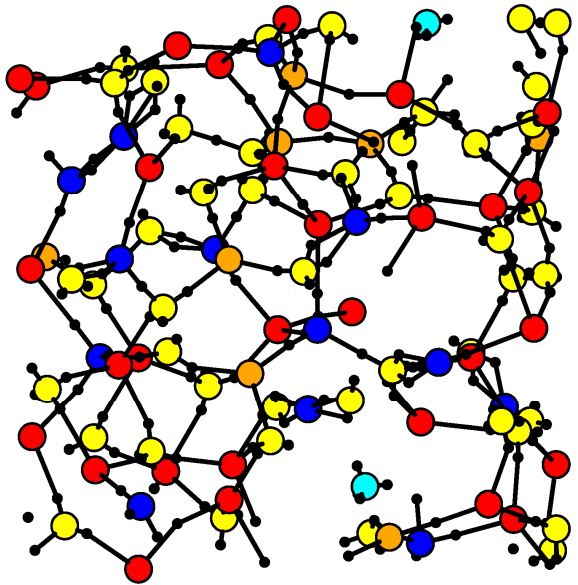
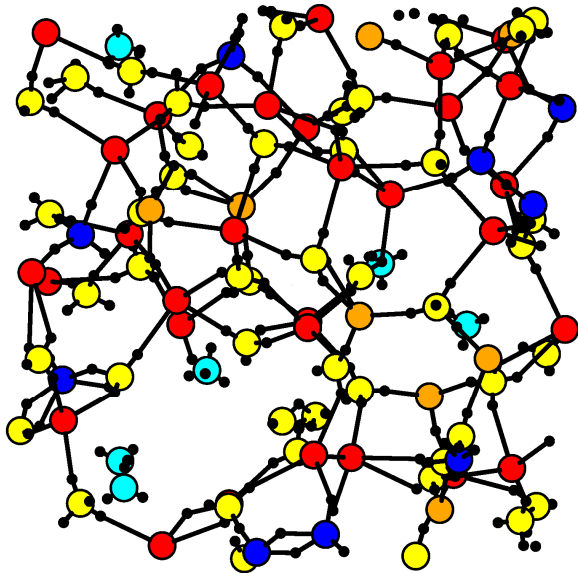
- $\text{Si}_{32}\text{B}_8\text{C}_6\text{N}_{54}$ [75% Si]
Single Si-N bonds
⇒ high coordination
- $\text{Si}_{11}\text{B}_{14}\text{C}_{39}\text{N}_{36}$ [5% Si]
Double C=N, C=C and B=N, and triple C≡N bonds
⇒ low coordination



Calculated bonding statistics and experimental verification

Composition $\text{Si}_{32}\text{B}_8\text{C}_6\text{N}_{54}$
(Ar, H, O neglected)

- Example of hard, transparent, thermally stable composition
- Comparison of bonding statistics with IR spectra (no oscillator strengths, single BN bonds in both c-BN and h-BN peaks)



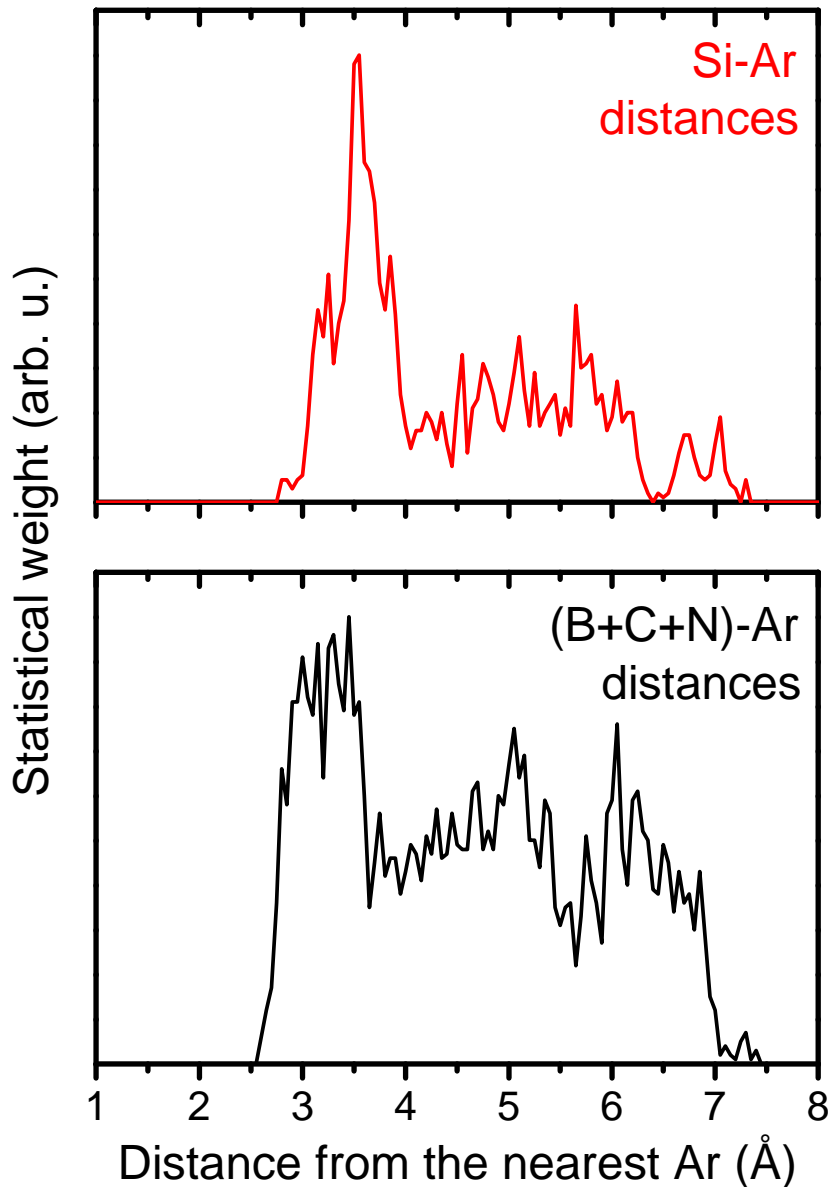
Molecular-dynamics simulations of Si-B-C-N-Ar materials

Si: ●, B: ●, C: ●, N: ●,
Ar: ●

2 valence electrons: —●—

- $\text{Si}_{31}\text{B}_8\text{C}_9\text{N}_{46}\text{Ar}_6$ [high $|U_b|$]
 $\text{Si}_{31}\text{B}_8\text{C}_{13}\text{N}_{46}\text{Ar}_2$ [low $|U_b|$]
 : formation of cavities with isolated Ar atoms
- Experimentally known effect of Ar content on material characteristics

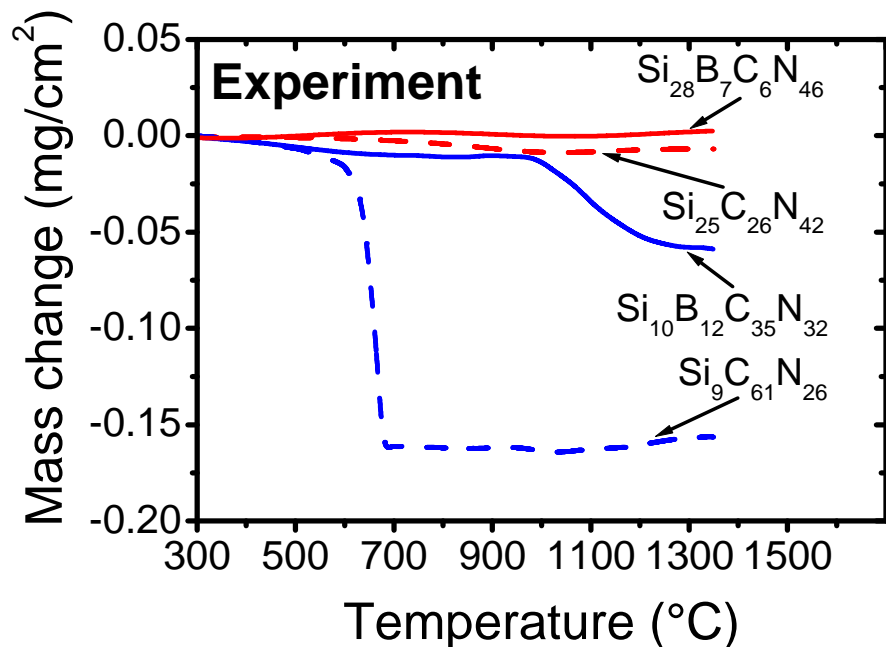
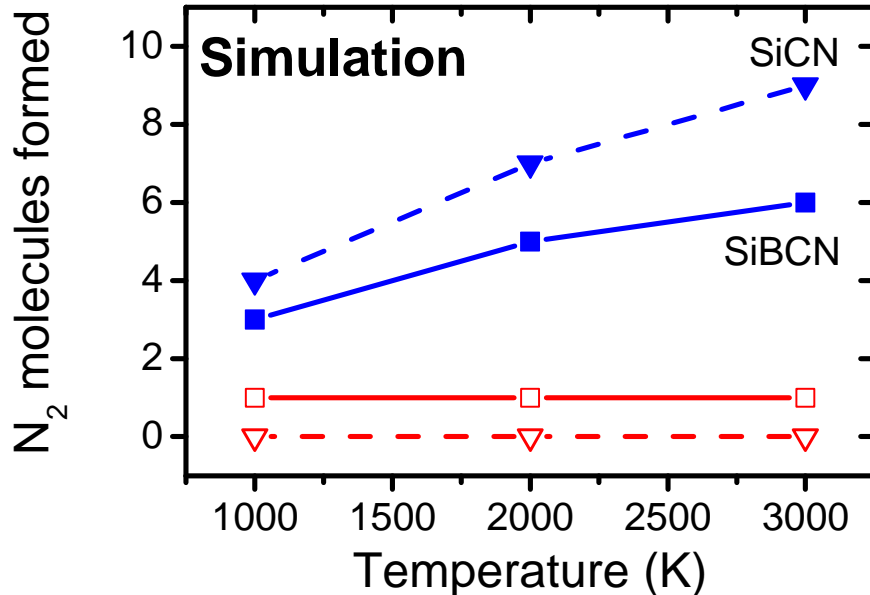
[J. Houska et al., J. Phys.: Condens. Matter 18, 2337 (2006)]



Effect of implanted Ar on Si-B-C-N materials (molecular dynamics)

Simulated composition
 $\text{Si}_{31}\text{B}_8\text{C}_{13}\text{N}_{46}\text{Ar}_2$

- Segregation of Si around Ar-cavities (long flexible bonds) \Rightarrow low energy penalty \Rightarrow **low stress**
- Formation of a two phase close-to-Ar (37% Si) and far-from-Ar (28 % Si) material \Rightarrow **enhanced extrinsic hardness**



Temperature stability of Si-(B)-C-N materials (molecular dynamics)

Simulated compositions

$Si_{39}B_{14}C_{11}N_{44}$, $Si_{53}C_{11}N_{44}$,
 $Si_{11}B_{14}C_{39}N_{44}$, $Si_{11}C_{53}N_{44}$

- Decomposition reactions
 $Si_3N_4 + 3C \rightarrow 3SiC + 2N_2$
 and $Si_3N_4 \rightarrow 3Si + 2N_2$
 \Rightarrow mass loss due to formation of N_2 molecules
- Less N_2 molecules formed at (1) higher Si/C ratio and (2) B addition

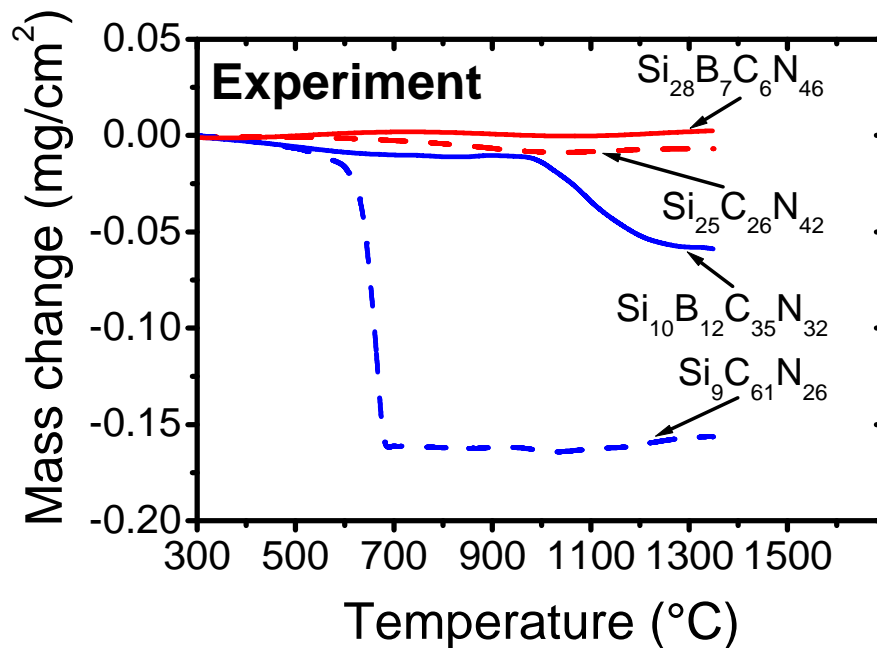
Simulation

bond type	bond lifetime 1000 K (%)	bond lifetime 2400 K (%)
low Si/C ($Si_{11}B_{14}C_{39}N_{36}$)		
Si-N	46	33
B-N	53	45
C-N	48	40
high Si/C ($Si_{32}B_8C_6N_{54}$)		
Si-N	82	59
B-N	89	70
C-N	96	68

Temperature stability of Si-(B)-C-N materials (molecular dynamics)

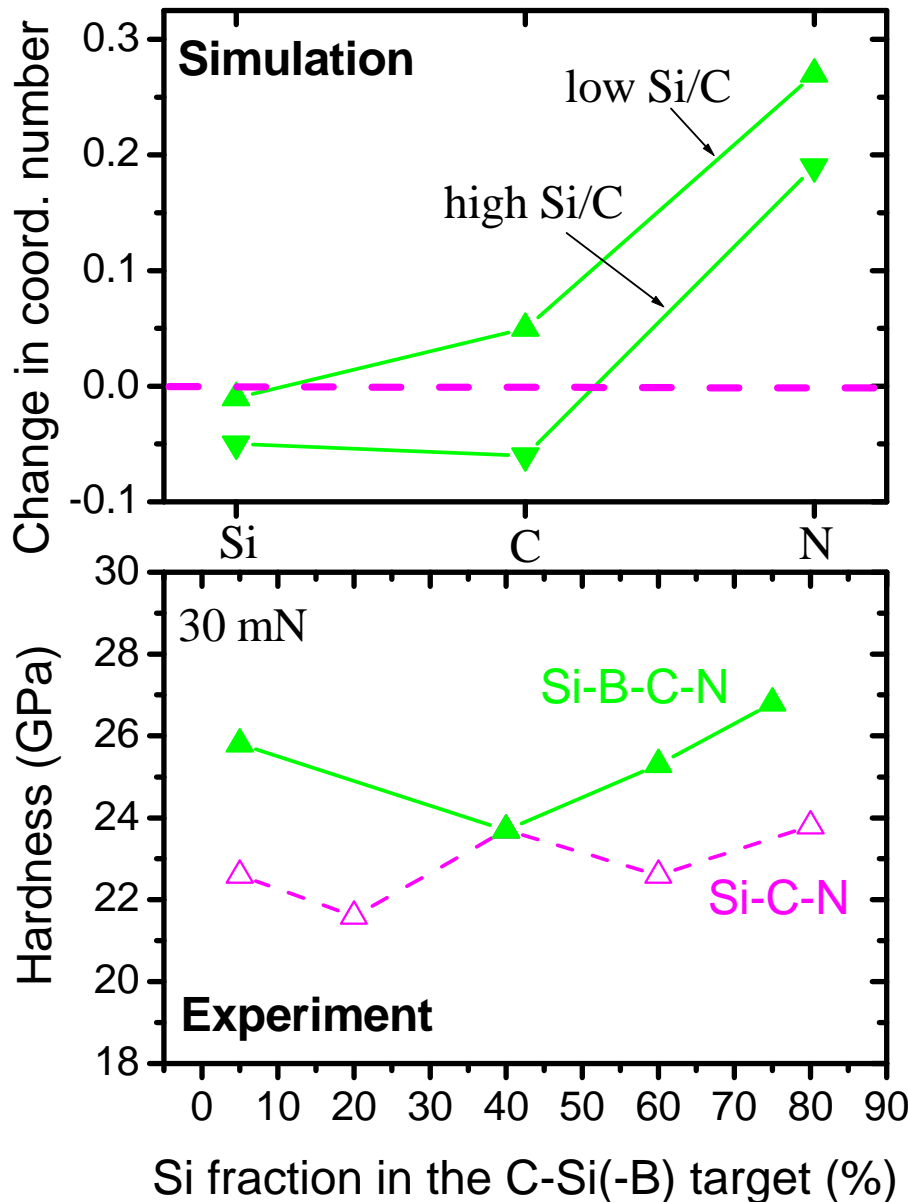
Simulated compositions

$Si_{32}B_8C_6N_{54}$, $Si_{11}B_{14}C_{39}N_{36}$



- Higher bond lifetimes in compositions with higher Si/C => more stable network => limited diffusion => decomposition reactions shifted to higher T => improved thermal stability

[J. Houska et al., Europhys. Lett. 76, 512 (2006)]



Role of B - comparing of Si-C-N and Si-B-C-N (experiment and molecular dynamics)

- Preferential bonding of B to N \Rightarrow converting of some N lonepairs to bonding electrons \Rightarrow higher nitrogen coordination
- Improved mechanical properties and thermal stability



CONCLUDING REMARKS

- **A complex quaternary system Si-B-C-N**: chemical bonding structure, electronic structure, high-temperature behaviour, role of energy, Si, B, C and implanted Ar
- **Support of an experiment by simulations**: providing information on atomic scale inaccessible experimentally
- **Difference between Si-based and C-based networks**: single Si bonds, many double and triple C bonds
- **Role of implanted Ar atoms**: segregation of Si around Ar-cavities \Rightarrow low stress, enhanced extrinsic hardness
- **High-temperature stability**: longer bond lifetimes at higher Si/C, lower rate of N_2 formation at higher Si/C and after addition of B